

## C1206C331K5RACTU

Aliases (C1206C331K5RAC7800) SMD Comm X7R, Ceramic, 330 pF, 10%, 50 VDC, X7R, SMD, MLCC, Temperature Stable, Class II, 1206, 1.5 mm



General Information	
Series	SMD Comm X7R
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Class II
Features	Temperature Stable, Class II
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	17 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	1206
L	3.2mm +/-0.2mm
W	1.6mm +/-0.2mm
Т	0.78mm +/-0.10mm
S	1.5mm MIN
В	0.5mm +/-0.25mm

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W	1.6mm +/-0.2mm	Tolerance	10%
Т	0.78mm +/-0.10mm	Voltage DC	50
S	1.5mm MIN	Dielectric Withstanding Voltage	125
В	0.5mm +/-0.25mm	Temperature Range	-55
		Temp. Coefficient	X7I
Packaging Specifications		Capacitance Change with	15%
Packaging	T&R, 180mm, Plastic Tape	Reference to +25°C and 0 VDC Applied (TCC)	
Packaging Quantity	4000	Discipation Foston	2 -

Specifications	
Capacitance	330 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	50 VDC
Dielectric Withstanding Voltage	125 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5% 1 kHz 1.0 Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

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